

Electronic Patent Application Fee Transmittal

Application Number:	10590046
Filing Date:	
Title of Invention:	Base Material for Pattern Forming Material, Positive Resist Composition and Method of Resist Formation
First Named Inventor/Applicant Name:	Taku Hirayama
Filer:	Neil S. Bartfeld/L. Racquel Raymond
Attorney Docket Number:	SHIGA7.055APC

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Late filing fee for oath or declaration	1051	1	130	130
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				130